









PRODUCT DATASHEET



- ► PTH/THT Lamp
- ➤ 3mm Cylindrical 3.8t
- ► Red/Green (645/525nm)

NOD31L38 (Bulk) NOD31L38T (Taping)



3mm Cylindrical Lamp



Release Date: 19 December 2023 Version: A1.1



FEATURES:

- Package: PTH/THT Lamp 3mm Cylindrical 3.8t Dual Colours
- Forward Current: 20/20mA*
- Forward Voltage (typ.): 2.0/3.3V
- Luminous Intensity (typ.): 200/900mcd@20mA
- Colour: Red/Green
- Dominant Wavelength (typ.): 625/525nm
- Viewing Angle: 160°
- Electrostatics Discharge (ESD): 200V
- **Materials:**
 - Die: AllnGaP/InGaN
 - Resin: Epoxy (White Diffused)
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- **Grouping Parameters:**
 - Forward voltage
 - Luminous intensity
 - Dominant wavelength
- Soldering Methods: Hand; Soldering Heat (DIP)
- Packing: 500pcs/bulk; 2000pcs/tape (ammo pack)

3 mm Cylindrical Lamp

APPLICATIONS:

- Indicator
- Switch
- Signal Light

^{*} in order of Red/Green



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	25/30*	mA
Peak Forward Current Duty 1/10@1KHz	I _{FP}	100	mA
Reverse Current @5V	IR	10	μА
Power Dissipation	P _D	85	mW
Electrostatics Discharge	ESD	200	V
Operating Temperature	T _{OPR}	-40~+85	°C
Storage Temperature	T _{STG}	-40~+100	°C

^{*} in order of Red/Green

Electrical & Optical Characteristics (Ta=25°C)

Darameter	Symbol	Values			Linit	Test
Parameter		Min.	Тур.	Max.	Unit	Condition
Forward Voltage	V_{F}	1.8/2.9*	2.0/3.2	2.5/3.6	V	I _F =20mA
Luminous Intensity	I _V	170/750	200/900	250/1300	mcd	I _F =20mA
Dominant Wavelength	λ_{D}	620/515	625/525	630/530	nm	I _F =20mA
Spectral Line Half- Width	Δλ		22/36		nm	I _F =20mA
Peak Wavelength	λ_{P}		635/525		nm	I _F =20mA
Viewing Angle	2θ _{1/2}		160		deg	I _F =20mA

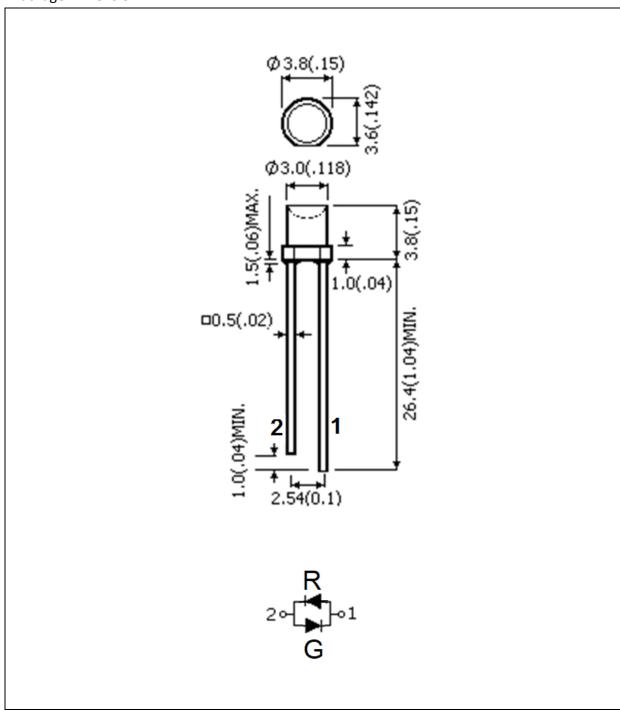
^{1.} Luminous intensity (I_V) ±15%, Forward Voltage (V_F) ±0.1V

^{2. *} in order of Red/Green



OUTLINE DIMENSION:

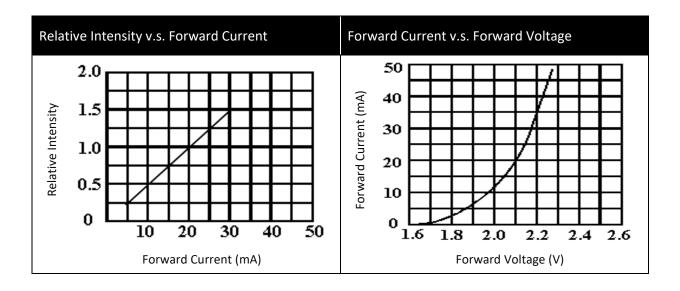
Package Dimension:

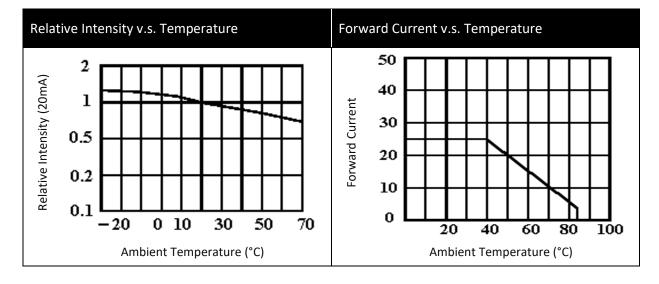


- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.25mm, unless otherwise noted.



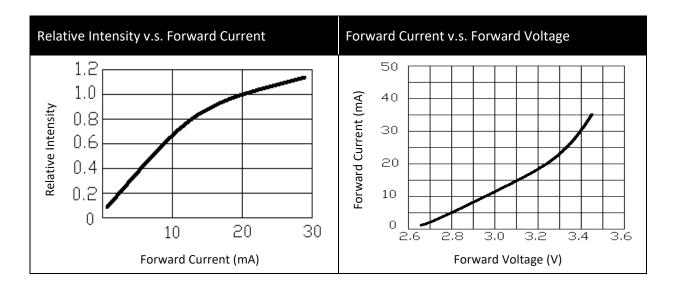
ELECTRO-OPTICAL CHARACTERISTICS (RED):

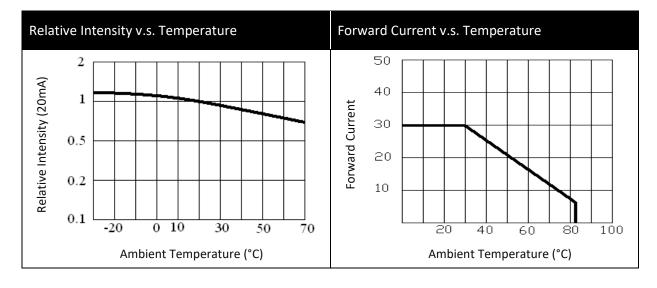






ELECTRO-OPTICAL CHARACTERISTICS (GREEN):





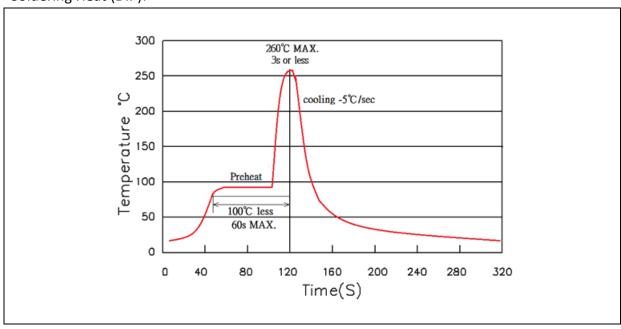


RECOMMENDED SOLDERING PROFILE:

Hand Solder (Solder Iron):

- Temperature at tip of iron: 350°C Max.
- Soldering Time: 3 seconds ± 1 sec.

Soldering Heat (DIP):

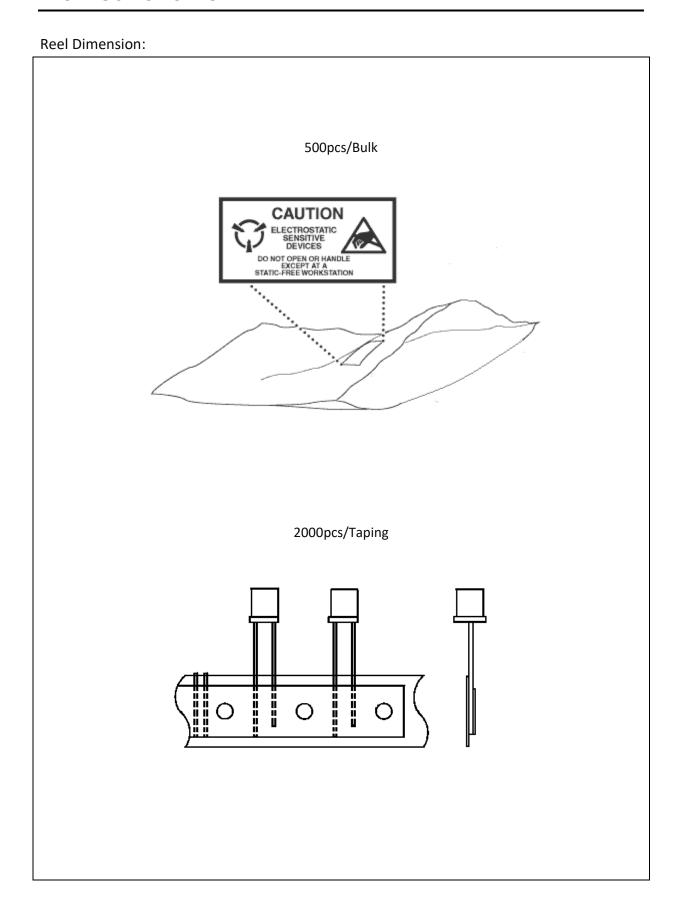


Note:

- 1. Maximum reflow soldering: 1 time.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a year. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

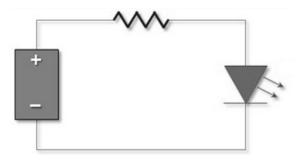
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±5°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	24/03/2023	Datasheet set-up.
A1.1	19/12/2023	Revise storage condition.